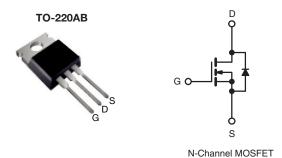
COMPLIANT



# **D Series Power MOSFET**

PRODUCT SUMMA	RODUCT SUMMARY			
V <sub>DS</sub> (V) at T <sub>J</sub> max.	450	)		
R <sub>DS(on)</sub> max. at 25 °C (Ω)	V <sub>GS</sub> = 10 V	1.0		
Q <sub>g</sub> max. (nC)	18			
Q <sub>gs</sub> (nC)	3			
Q <sub>gd</sub> (nC)	4			
Configuration	Sing	le		



#### **FEATURES**

- Optimal Design
  - Low Area Specific On-Resistance
  - Low Input Capacitance (Ciss)
  - Reduced Capacitive Switching Losses
  - High Body Diode Ruggedness
  - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
  - Low Cost
  - Simple Gate Drive Circuitry
  - Low Figure-of-Merit (FOM): Ron x Qg
  - Fast Switching
- Material categorization: For definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### Note

Lead (Pb)-containing terminations are not RoHS-compliant. Exemptions may apply.

## **APPLICATIONS**

- Consumer Electronics
  - Displays (LCD or Plasma TV)
- Server and Telecom Power Supplies
  - SMPS
- Industrial
  - Welding
  - Induction Heating
- Motor Drives
- Battery Chargers

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF730BPbF

ABSOLUTE MAXIMUM RATINGS (To	= 25 °C, unless otherwi	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		$V_{DS}$	400		
Gate-Source Voltage		V	± 30	V	
Gate-Source Voltage AC (f > 1 Hz)		$V_{GS}$	30		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	$V_{GS}$ at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$	I <sub>D</sub>	6	1	
	$T_C = 100 ^{\circ}C$		4	Α	
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	13	i		
Linear Derating Factor			0.8	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>		E <sub>AS</sub>	104	mJ	
Maximum Power Dissipation	$P_{D}$	104	W		
Operating Junction and Storage Temperature Ran	T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C		
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C	dV/dt	24	V/ns	
Reverse Diode dV/dt <sup>d</sup>		uv/at	0.48	V/IIS	
Soldering Recommendations (Peak Temperature)	for 10 s		300°	°C	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 2.3 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 9.5 A.
- c. 1.6 mm from case.
- d.  $I_{SD} \leq I_{D}$ , starting  $T_{J}$  = 25 °C.



# Vishay Siliconix

THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	°C/W
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	1.2	G/ <b>VV</b>

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		1					
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		400	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>D</sub> = 250 μA	-	0.53	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	3	-	5	V
Gate-Source Leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 30 V	-	-	± 100	nA
Zava Cata Valtaga Dvain Cuwant	I <sub>DSS</sub>	V <sub>DS</sub> =	V <sub>DS</sub> = 400 V, V <sub>GS</sub> = 0 V		-	1	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 320 V	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 3 A	-	0.85	1.0	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	$_{\rm I} = 50 \text{ V}, I_{\rm D} = 3 \text{ A}$	-	1.7	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	311	-	
Output Capacitance	C <sub>oss</sub>	]	$V_{DS} = 100 \text{ V},$	-	38	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	1	f = 1 MHz		7	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 0 V to 320 V		-	44	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	54	-	
Total Gate Charge	Qg			-	9	18	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 3 A, V <sub>DS</sub> = 320 V		_	3	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	]		-	4	-	
Turn-On Delay Time	t <sub>d(on)</sub>			-	12	24	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 400 V, $I_D$ = 3 A, $V_{GS}$ = 10 V, $R_g$ = 9.1 $\Omega$		-	11	22	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	14	28	ns
Fall Time	t <sub>f</sub>			-	8	16	
Gate Input Resistance	$R_g$	f = 1 MHz, open drain		-	1.9	-	Ω
Drain-Source Body Diode Characteristic							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	6	_
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	24	A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 3 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse Recovery Time	t <sub>rr</sub>			-	236	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 2$	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 3 \text{A},$		1.1	-	μC
Reverse Recovery Current	I <sub>RRM</sub>	$dI/dt = 100 \text{ A/}\mu\text{s}, \text{ V}_{R} = 20 \text{ V}$		_	9	_	A

## Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .
- b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

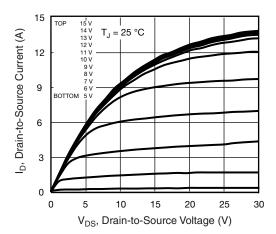


Fig. 1 - Typical Output Characteristics

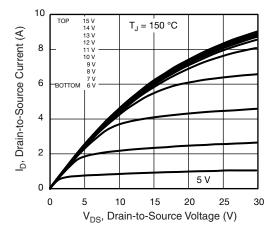


Fig. 2 - Typical Output Characteristics

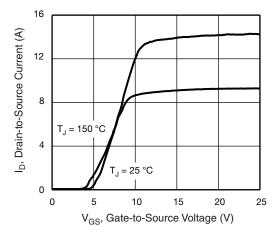


Fig. 3 - Typical Transfer Characteristics

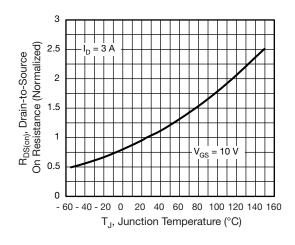


Fig. 4 - Normalized On-Resistance vs. Temperature

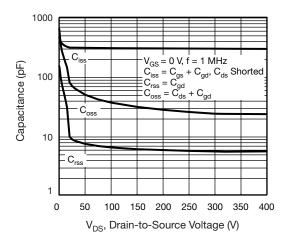


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

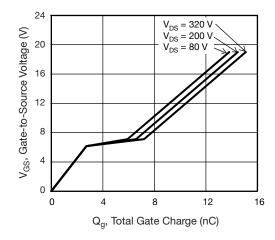


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



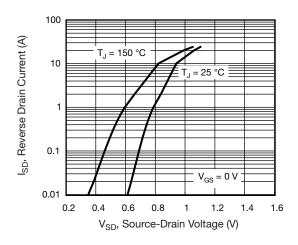


Fig. 7 - Typical Source-Drain Diode Forward Voltage

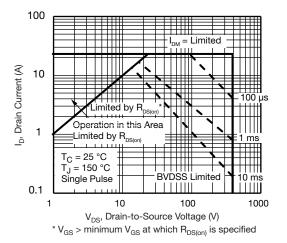


Fig. 8 - Maximum Safe Operating Area

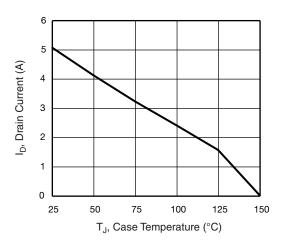


Fig. 9 - Maximum Drain Current vs. Case Temperature

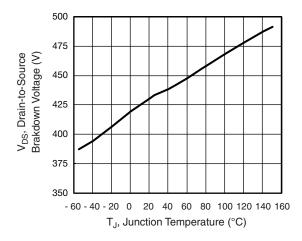


Fig. 10 - Temperature vs. Drain-to-Source Voltage

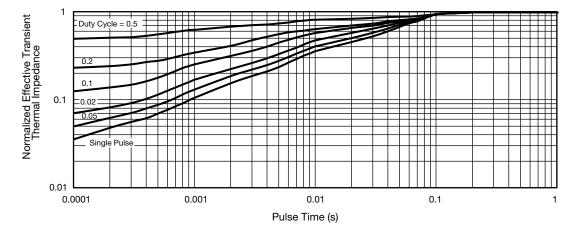


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



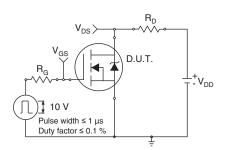


Fig. 12 - Switching Time Test Circuit

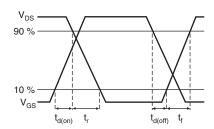


Fig. 13 - Switching Time Waveforms

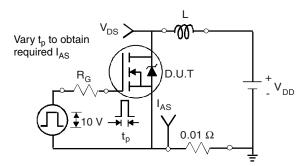


Fig. 14 - Unclamped Inductive Test Circuit

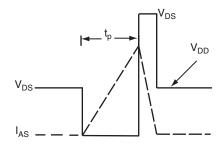


Fig. 15 - Unclamped Inductive Waveforms

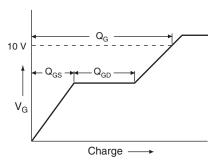


Fig. 16 - Basic Gate Charge Waveform

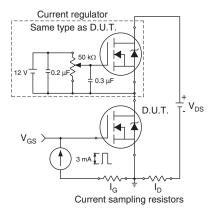
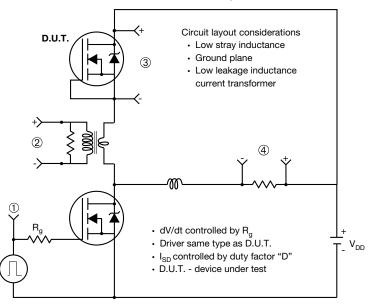


Fig. 17 - Gate Charge Test Circuit



## Peak Diode Recovery dV/dt Test Circuit



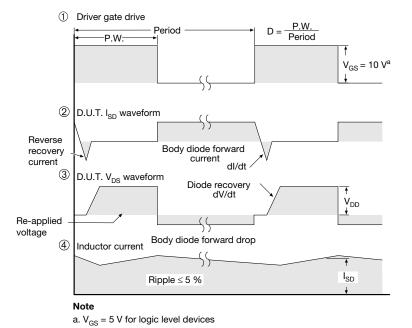
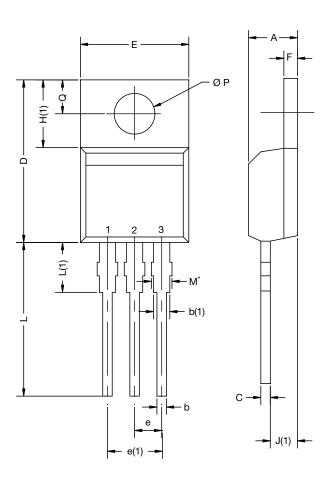


Fig. 18 - For N-Channel

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# TO-220-1



DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
Α	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
Е	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

## Note

DWG: 6031

•  $M^* = 0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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Vishay

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